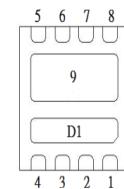
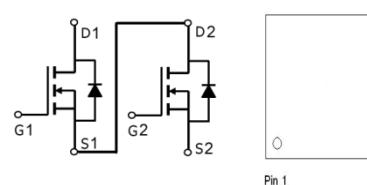


NIKO-SEM
**Dual N-Channel Enhancement Mode
Field Effect Transistor**
PE674DT
PDFN 3x3S
Halogen-Free & Lead-Free
PRODUCT SUMMARY

	$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
Q2	30V	7mΩ	39A
Q1	30V	10.5mΩ	31A

**ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	Q2	Q1	UNITS
Drain-Source Voltage		V_{DS}	30	30	V
Gate-Source Voltage		V_{GS}	± 20	± 20	V
Continuous Drain Current ³	$T_C = 25^\circ\text{C}$	I_D	39	31	A
	$T_C = 100^\circ\text{C}$		25	20	
Pulsed Drain Current ¹		I_{DM}	50	45	
Continuous Drain Current ³	$T_A = 25^\circ\text{C}$	I_D	12	9.5	W
	$T_A = 70^\circ\text{C}$		10	7.6	
Avalanche Current		I_{AS}	23	17.5	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	26.4	15.3	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$	P_D	20	19	W
	$T_C = 100^\circ\text{C}$		8.3	7.6	
Power Dissipation	$T_A = 25^\circ\text{C}$	P_D	2.2	1.7	W
	$T_A = 70^\circ\text{C}$		1.4	1.1	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL		TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$R_{\theta JA}$	Q2		56	°C / W
	$R_{\theta JA}$	Q1		72	
Junction-to-Case	$R_{\theta JC}$	Q2		6	
	$R_{\theta JC}$	Q1		6.5	

¹Pulse width limited by maximum junction temperature $T_{J(MAX)}=150^\circ\text{C}$.²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The value in any given application depends on the user's specific board design.³Package limitation current is Q2=19A , Q1=11A.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT		
			MIN	TYP	MAX			
STATIC								
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250µA	Q2	30		V		
			Q1	30				
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250µA	Q2	1.3	1.75	2.3		
			Q1	1.3	1.75	2.3		
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V	Q2			±100		
			Q1			±100		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V	Q2			1		
			Q1			1		
		V _{DS} = 20V, V _{GS} = 0V, T _J = 55 °C	Q2			10		
			Q1			10		
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 10A	Q2		6.7	9.5		
		V _{GS} = 4.5V, I _D = 9A	Q1		10.2	15.5		
		V _{GS} = 10V, I _D = 10A	Q2		5	7		
		V _{GS} = 10V, I _D = 9.5A	Q1		7.5	10.5		
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 10A	Q2		66			
		V _{DS} = 5V, I _D = 9.5A	Q1		50			
DYNAMIC								
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz	Q2		961		pF	
			Q1		627			
Output Capacitance	C _{oss}		Q2		185			
			Q1		129			
Reverse Transfer Capacitance	C _{rss}		Q2		121			
			Q1		97			
Total Gate Charge ²	Q _g	V _{GS} = 10V V _{GS} = 4.5V	Q2	15.4	19.3	23.2	nC	
			Q1	11.2	14	16.8		
			Q2	7.8	11.2	14.6		
			Q1	5.5	7.8	10.1		
Gate-Source Charge ²	Q _{gs}	V _{DS} = 15V, V _{GS} = 10V, I _D = 10A V _{DS} = 15V, V _{GS} = 10V, I _D = 9.5A	Q2		2.1		nC	
			Q1		1.6			
Gate-Drain Charge ²	Q _{gd}		Q2		5.9			
			Q1		4.1			

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Turn-On Delay Time ²	$t_{d(on)}$	Q2 $V_{DS} = 15V$, $I_D \geq 10A$, $V_{GS} = 10V$, $R_{GEN} = 6\Omega$ Q1 $V_{DS} = 15V$, $I_D \geq 9.5A$, $V_{GS} = 10V$, $R_{GEN} = 6\Omega$	Q2		13		nS
Rise Time ²	t_r		Q1		12		
Turn-Off Delay Time ²	$t_{d(off)}$		Q2		57		
Fall Time ²	t_f		Q1		48		
			Q2		35		
			Q1		27		
			Q2		70		
			Q1		39		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)

Continuous Current ³	I_S	Q2 Q1			16	A
Forward Voltage ¹	V_{SD}		Q2		1.2	
Reverse Recovery Time	t_{rr}	Q1	$I_F = 10A$, $V_{GS} = 0V$		1.1	V
			$I_F = 9.5A$, $V_{GS} = 0V$			
Reverse Recovery Charge	Q_{rr}	Q2		12		nS
		Q1		10.5		
		Q2		3		nC
		Q1		3		

¹Pulse test : Pulse Width ≤ 300 μ sec, Duty Cycle $\leq 2\%$.²Independent of operating temperature.³Package limitation current is Q2=19A , Q1=11A.

NIKO-SEM

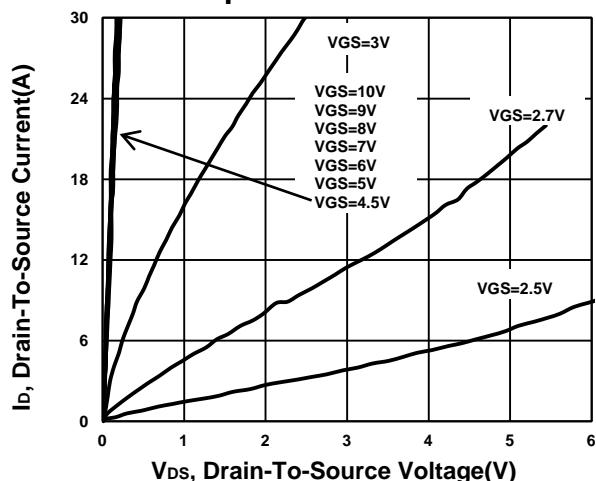
**Dual N-Channel Enhancement Mode
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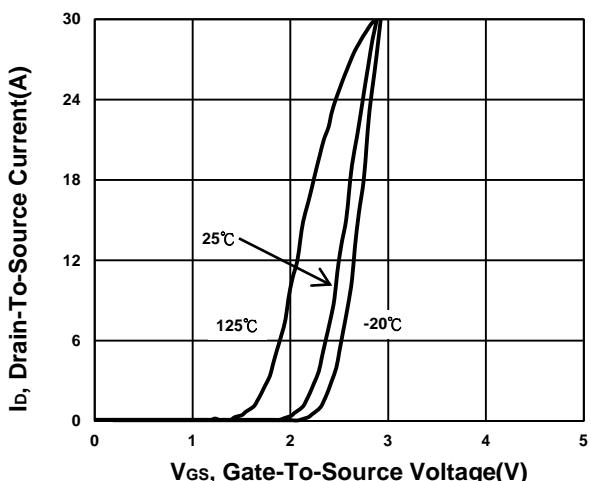
TYPICAL PERFORMANCE CHARACTERISTICS

Q2

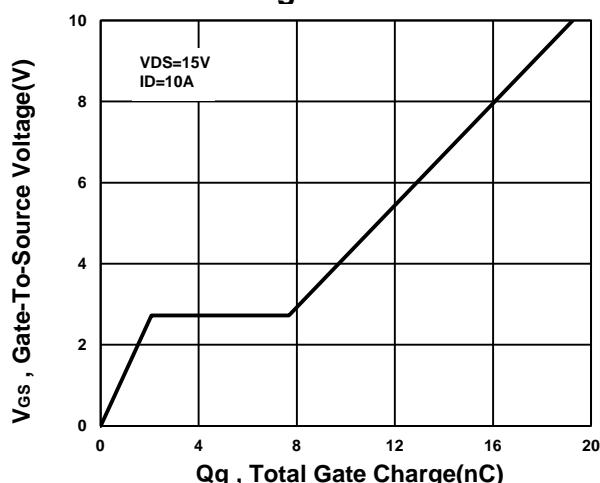
Output Characteristics



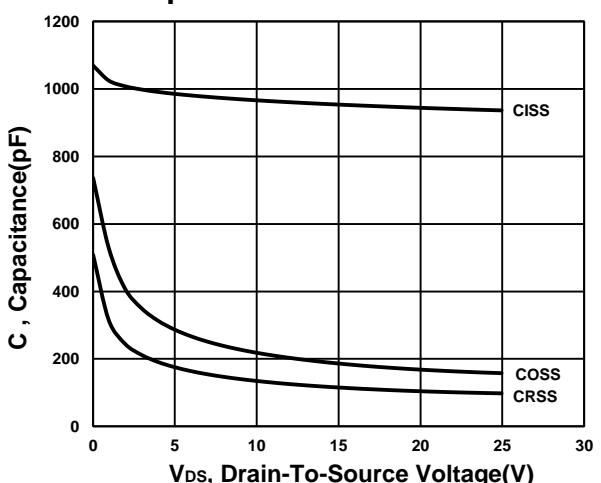
Transfer Characteristics



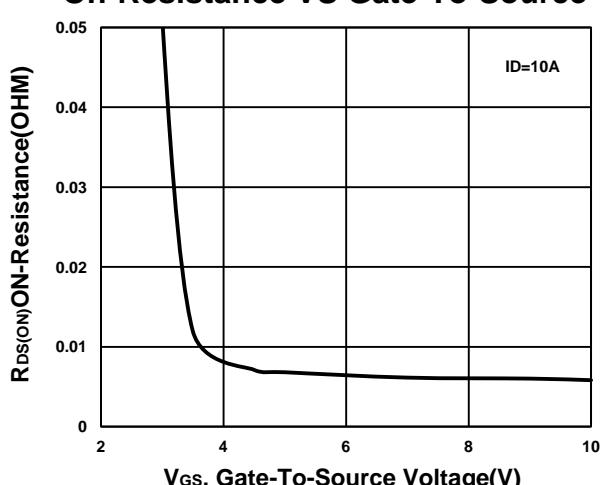
Gate charge Characteristics



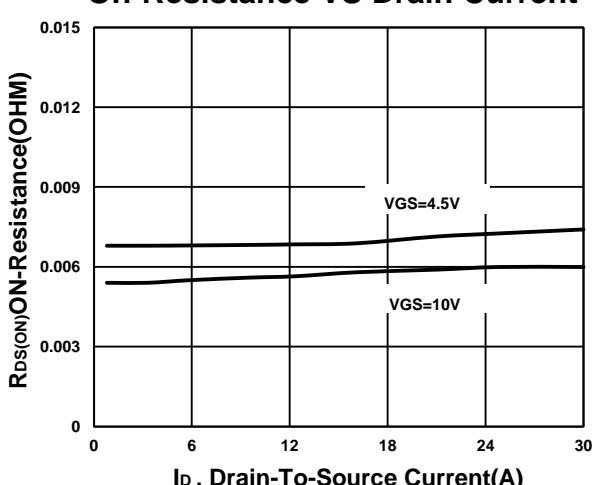
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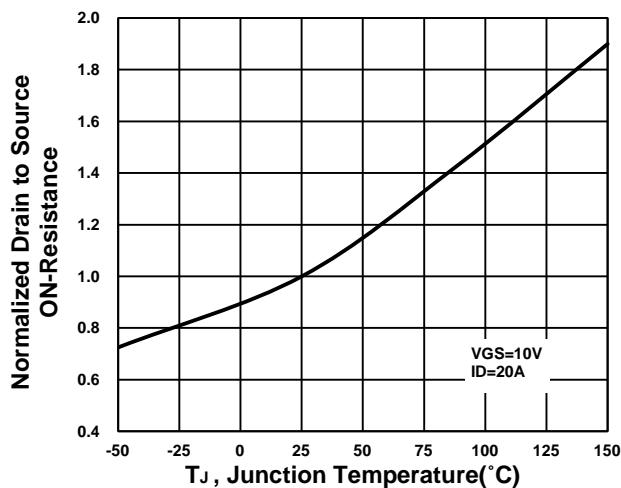
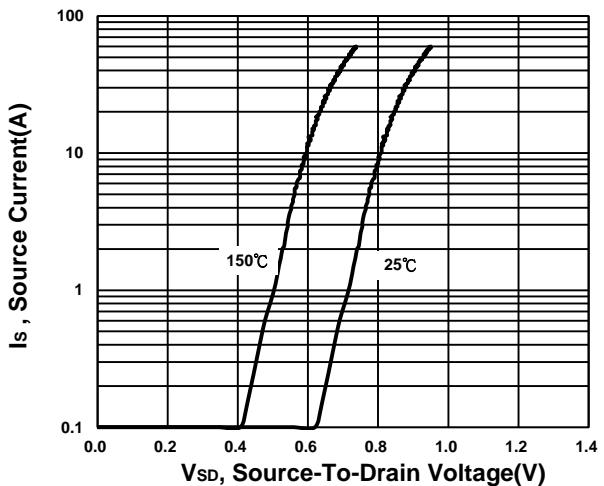
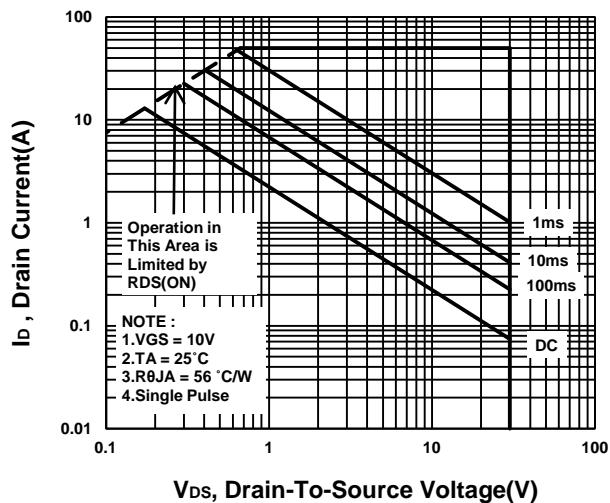
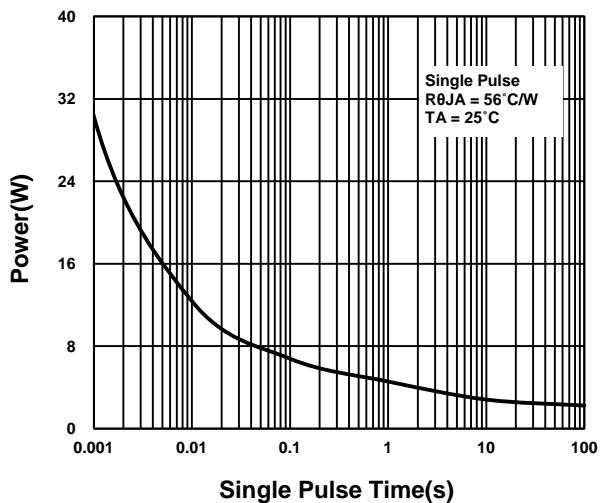
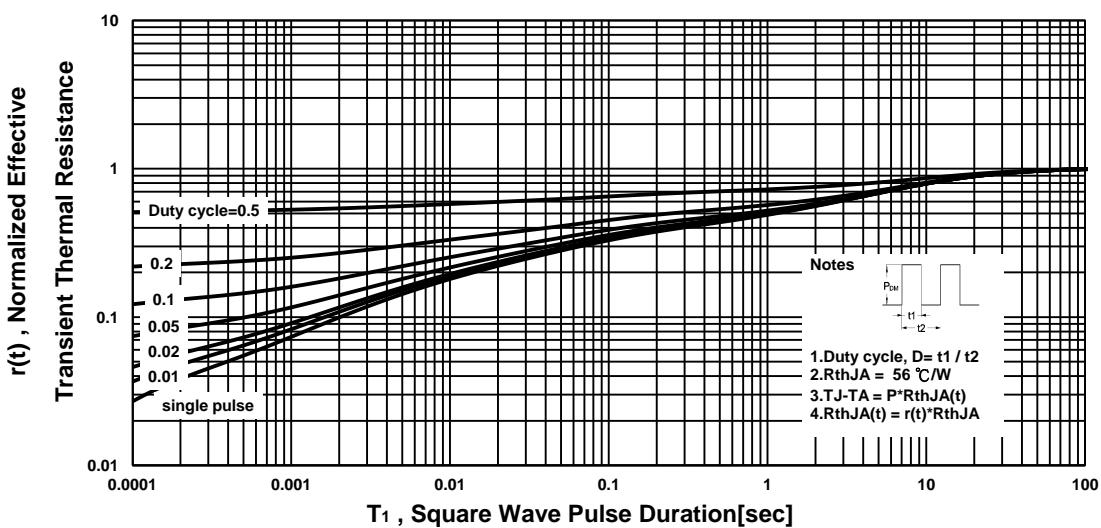


On-Resistance VS Gate-To-Source



On-Resistance VS Drain Current



NIKO-SEM**Dual N-Channel Enhancement Mode
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Halogen-Free & Lead-Free**On-Resistance VS Temperature****Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**

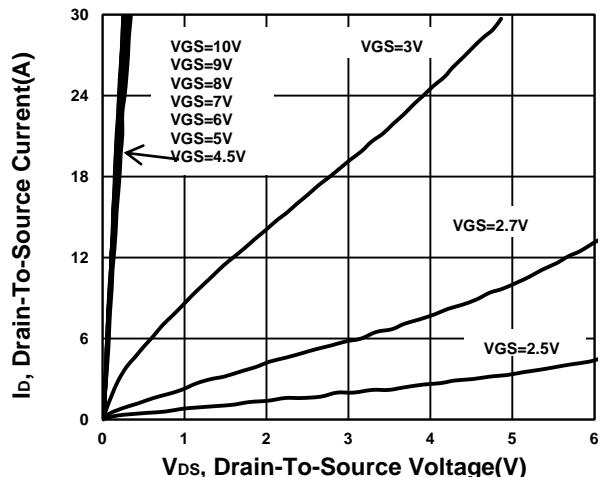
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**Dual N-Channel Enhancement Mode
Field Effect Transistor**

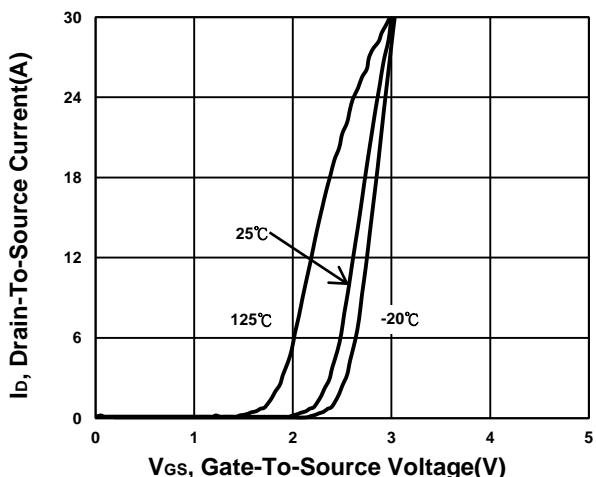
PE674DT
PDFN 3x3S
Halogen-Free & Lead-Free

Q1

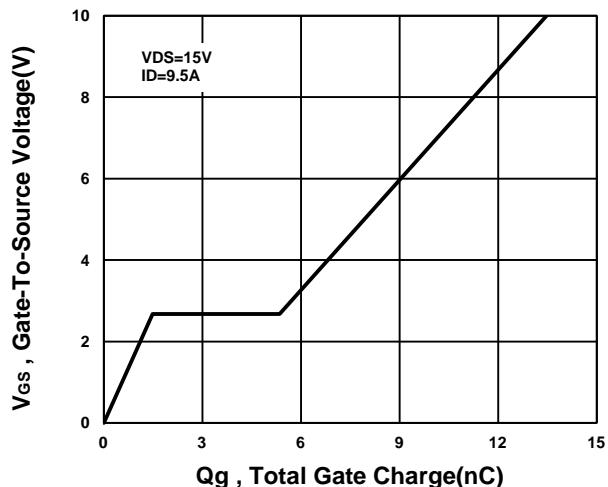
Output Characteristics



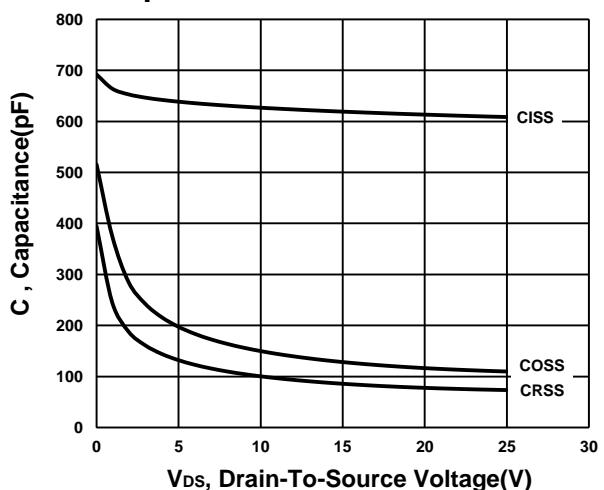
Transfer Characteristics



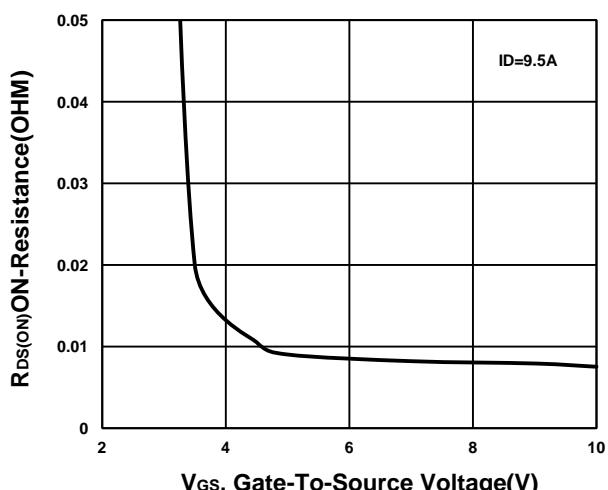
Gate charge Characteristics



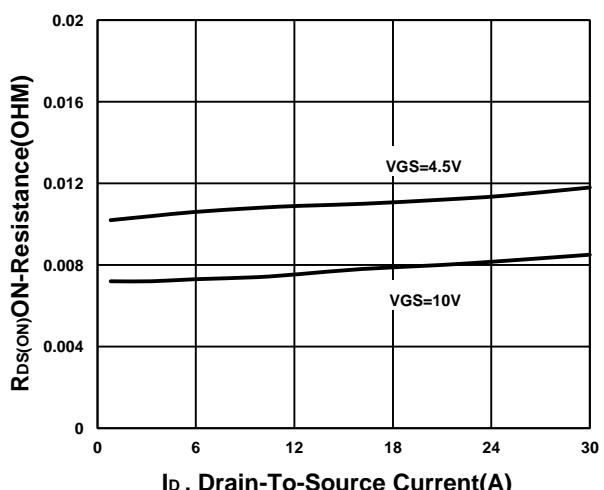
Capacitance Characteristic

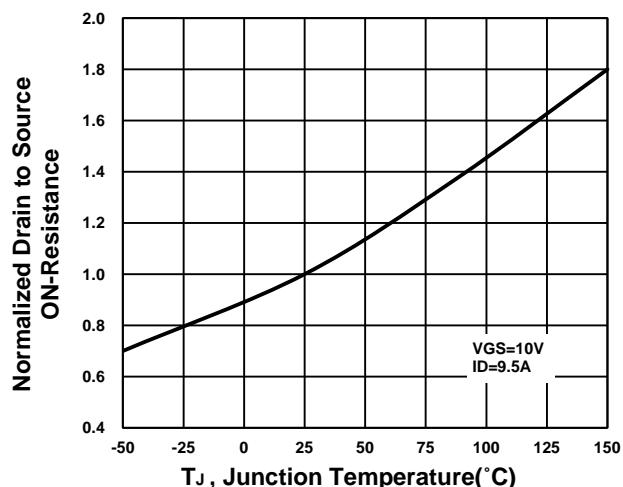
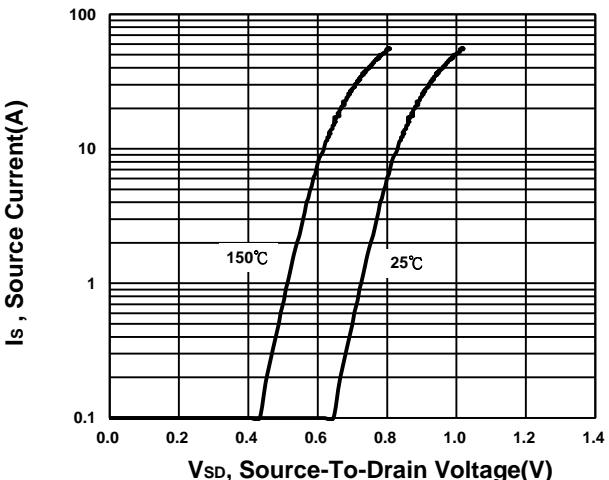
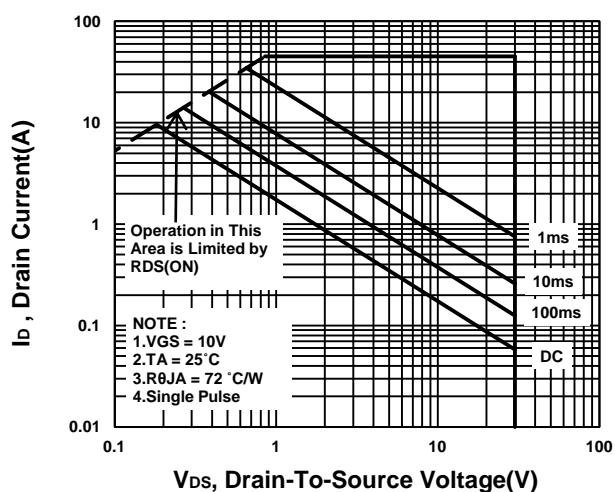
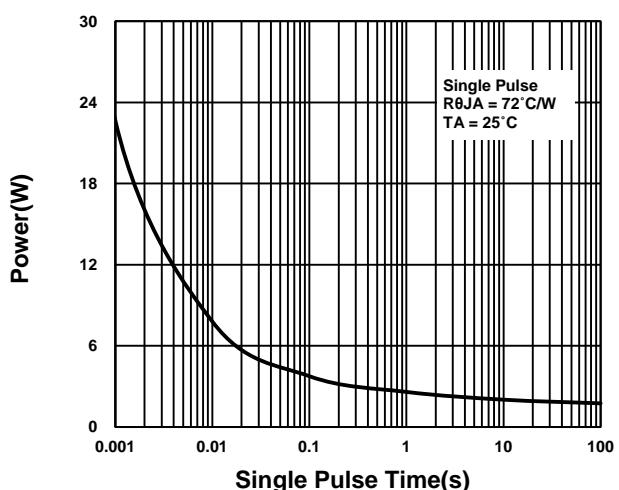


On-Resistance VS Gate-To-Source



On-Resistance VS Drain Current



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